

## OptiMOS™-5 Power-Transistor



### Features

- N-channel - Enhancement mode
- AEC-Q101 qualified
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green product (RoHS compliant)
- Ultra low Rds(on)
- 100% Avalanche tested

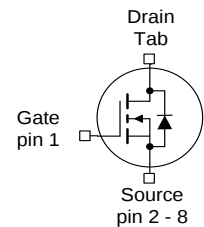
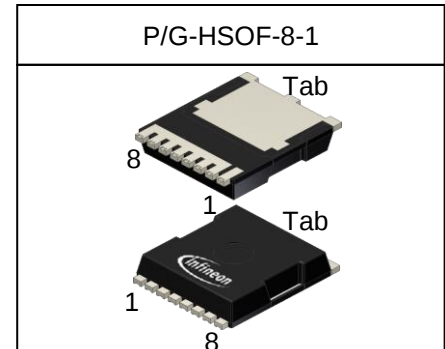
| Type             | Package      | Marking |
|------------------|--------------|---------|
| IAUT260N10S5N019 | P/G-HSOF-8-1 | 5N10019 |

**Maximum ratings**, at  $T_j=25\text{ °C}$ , unless otherwise specified

| Parameter                                    | Symbol         | Conditions                                         | Value        | Unit |
|----------------------------------------------|----------------|----------------------------------------------------|--------------|------|
| Continuous drain current                     | $I_D$          | $T_C=25\text{ °C}$ , $V_{GS}=10\text{ V}$          | 260          | A    |
|                                              |                | $T_C=100\text{ °C}$ ,<br>$V_{GS}=10\text{ V}^{1)}$ | 197          |      |
| Pulsed drain current <sup>1)</sup>           | $I_{D,pulse}$  | $T_C=25\text{ °C}$                                 | 1040         |      |
| Avalanche energy, single pulse <sup>1)</sup> | $E_{AS}$       | $I_D=130\text{ A}$                                 | 400          | mJ   |
| Avalanche current, single pulse              | $I_{AS}$       | -                                                  | 220          | A    |
| Gate source voltage                          | $V_{GS}$       | -                                                  | ±20          | V    |
| Power dissipation                            | $P_{tot}$      | $T_C=25\text{ °C}$                                 | 300          | W    |
| Operating and storage temperature            | $T_j, T_{stg}$ | -                                                  | -55 ... +175 | °C   |
| IEC climatic category; DIN IEC 68-1          | -              | -                                                  | 55/175/56    |      |

### Product Summary

|              |     |    |
|--------------|-----|----|
| $V_{DS}$     | 100 | V  |
| $R_{DS(on)}$ | 1.9 | mΩ |
| $I_D$        | 260 | A  |



| Parameter | Symbol | Conditions | Values |      |      | Unit |
|-----------|--------|------------|--------|------|------|------|
|           |        |            | min.   | typ. | max. |      |

### Thermal characteristics<sup>1)</sup>

|                                     |            |   |   |   |     |     |
|-------------------------------------|------------|---|---|---|-----|-----|
| Thermal resistance, junction - case | $R_{thJC}$ | - | - | - | 0.5 | K/W |
|-------------------------------------|------------|---|---|---|-----|-----|

### Electrical characteristics, at $T_j=25\text{ }^{\circ}\text{C}$ , unless otherwise specified

#### Static characteristics

|                                  |               |                                                                                       |     |     |     |               |
|----------------------------------|---------------|---------------------------------------------------------------------------------------|-----|-----|-----|---------------|
| Drain-source breakdown voltage   | $V_{(BR)DSS}$ | $V_{GS}=0\text{ V}$ ,<br>$I_D=1\text{ mA}$                                            | 100 | -   | -   | V             |
| Gate threshold voltage           | $V_{GS(th)}$  | $V_{DS}=V_{GS}$ , $I_D=210\text{ }\mu\text{A}$                                        | 2.2 | 3.0 | 3.8 |               |
| Zero gate voltage drain current  | $I_{DSS}$     | $V_{DS}=100\text{ V}$ , $V_{GS}=0\text{ V}$ ,<br>$T_j=25\text{ }^{\circ}\text{C}$     | -   | 0.1 | 1   | $\mu\text{A}$ |
|                                  |               | $V_{DS}=50\text{ V}$ , $V_{GS}=0\text{ V}$ ,<br>$T_j=85\text{ }^{\circ}\text{C}^{1)}$ | -   | 1   | 20  |               |
| Gate-source leakage current      | $I_{GSS}$     | $V_{GS}=20\text{ V}$ , $V_{DS}=0\text{ V}$                                            | -   | -   | 100 | nA            |
| Drain-source on-state resistance | $R_{DS(on)}$  | $V_{GS}=6\text{ V}$ , $I_D=65\text{ A}$                                               | -   | 2.0 | 2.5 | m $\Omega$    |
|                                  |               | $V_{GS}=10\text{ V}$ , $I_D=100\text{ A}$                                             | -   | 1.6 | 1.9 |               |

| Parameter | Symbol | Conditions | Values |      |      | Unit |
|-----------|--------|------------|--------|------|------|------|
|           |        |            | min.   | typ. | max. |      |

#### Dynamic characteristics<sup>1)</sup>

|                              |              |                                                                                  |   |      |       |    |
|------------------------------|--------------|----------------------------------------------------------------------------------|---|------|-------|----|
| Input capacitance            | $C_{iss}$    | $V_{GS}=0\text{ V}, V_{DS}=50\text{ V},$<br>$f=1\text{ MHz}$                     | - | 9100 | 11830 | pF |
| Output capacitance           | $C_{oss}$    |                                                                                  | - | 1462 | 1900  |    |
| Reverse transfer capacitance | $C_{rss}$    |                                                                                  | - | 61   | 92    |    |
| Turn-on delay time           | $t_{d(on)}$  | $V_{DD}=50\text{ V}, V_{GS}=10\text{ V},$<br>$I_D=100\text{ A}, R_G=3.5\ \Omega$ | - | 21   | -     | ns |
| Rise time                    | $t_r$        |                                                                                  | - | 11   | -     |    |
| Turn-off delay time          | $t_{d(off)}$ |                                                                                  | - | 49   | -     |    |
| Fall time                    | $t_f$        |                                                                                  | - | 38   | -     |    |

#### Gate Charge Characteristics<sup>1)</sup>

|                       |               |                                                                             |   |     |     |    |
|-----------------------|---------------|-----------------------------------------------------------------------------|---|-----|-----|----|
| Gate to source charge | $Q_{gs}$      | $V_{DD}=50\text{ V}, I_D=100\text{ A},$<br>$V_{GS}=0\text{ to }10\text{ V}$ | - | 41  | 54  | nC |
| Gate to drain charge  | $Q_{gd}$      |                                                                             | - | 28  | 42  |    |
| Gate charge total     | $Q_g$         |                                                                             | - | 128 | 166 |    |
| Gate plateau voltage  | $V_{plateau}$ |                                                                             | - | 4.8 | -   | V  |

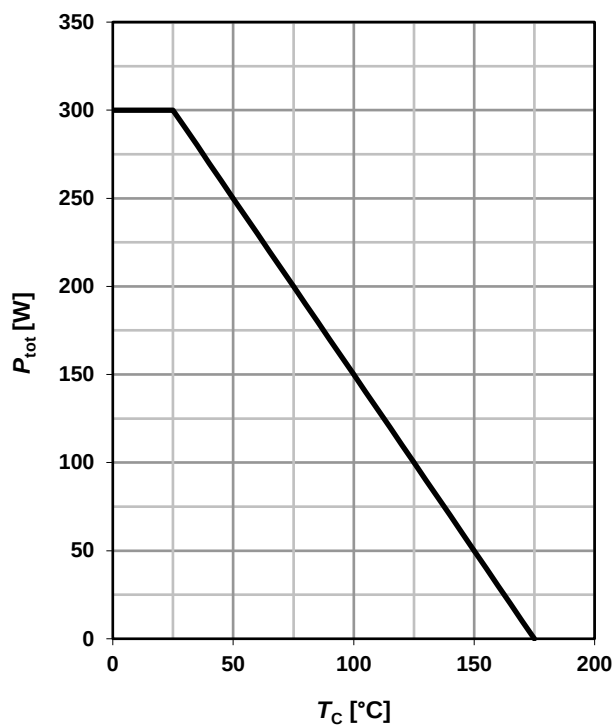
#### Reverse Diode

|                                                |               |                                                                           |   |     |      |    |
|------------------------------------------------|---------------|---------------------------------------------------------------------------|---|-----|------|----|
| Diode continuous forward current <sup>1)</sup> | $I_S$         | $T_C=25\text{ °C}$                                                        | - | -   | 260  | A  |
| Diode pulse current <sup>1)</sup>              | $I_{S,pulse}$ |                                                                           | - | -   | 1040 |    |
| Diode forward voltage                          | $V_{SD}$      | $V_{GS}=0\text{ V}, I_F=100\text{ A},$<br>$T_J=25\text{ °C}$              | - | 0.9 | 1.3  | V  |
| Reverse recovery time <sup>1)</sup>            | $t_{rr}$      | $V_R=50\text{ V}, I_F=50\text{ A},$<br>$di_F/dt=100\text{ A}/\mu\text{s}$ | - | 80  | -    | ns |
| Reverse recovery charge <sup>1)</sup>          | $Q_{rr}$      |                                                                           | - | 180 | -    | nC |

<sup>1)</sup> Defined by design. Not subject to production test.

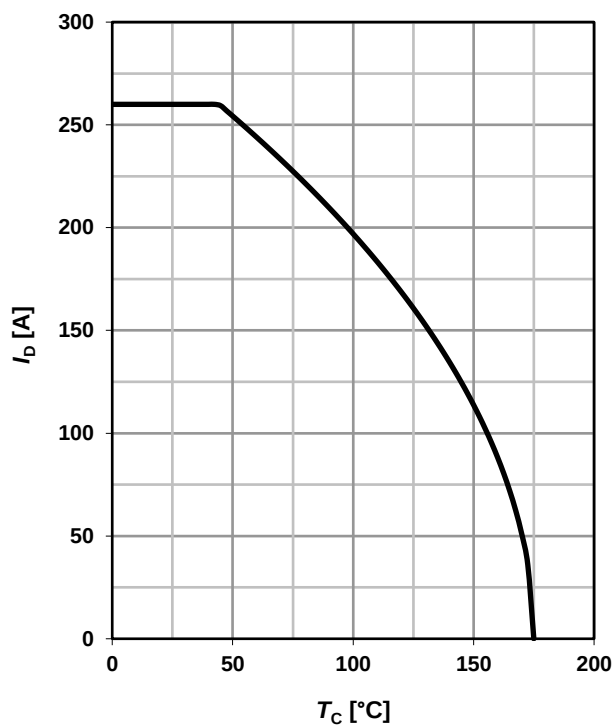
### 1 Power dissipation

$$P_{\text{tot}} = f(T_C); V_{\text{GS}} \geq 6 \text{ V}$$



### 2 Drain current

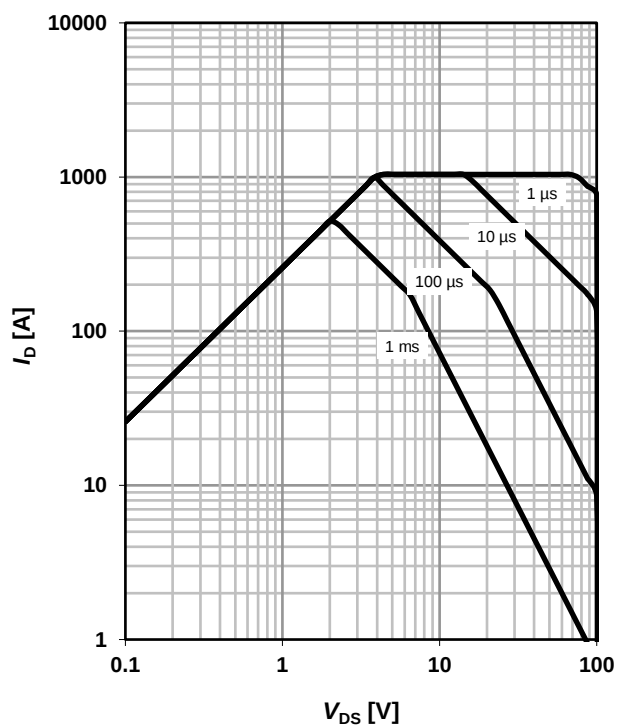
$$I_D = f(T_C); V_{\text{GS}} \geq 6 \text{ V}$$



### 3 Safe operating area

$$I_D = f(V_{\text{DS}}); T_C = 25 \text{ °C}; D = 0$$

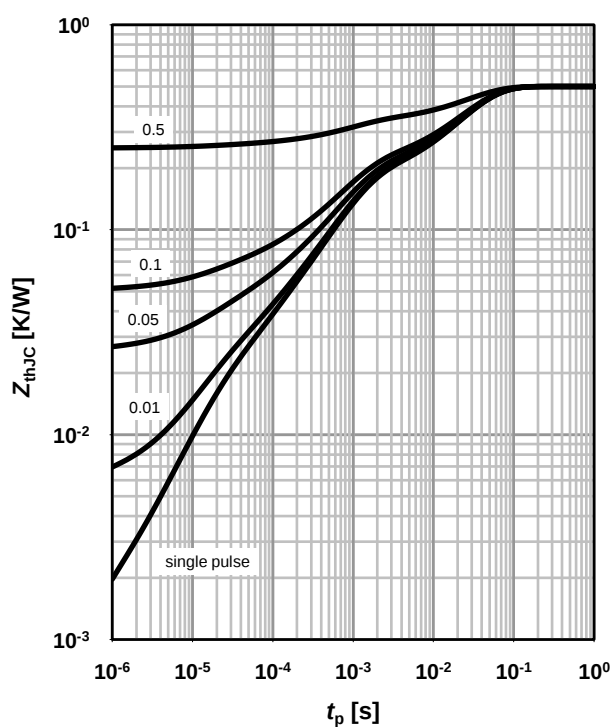
parameter:  $t_p$



### 4 Max. transient thermal impedance

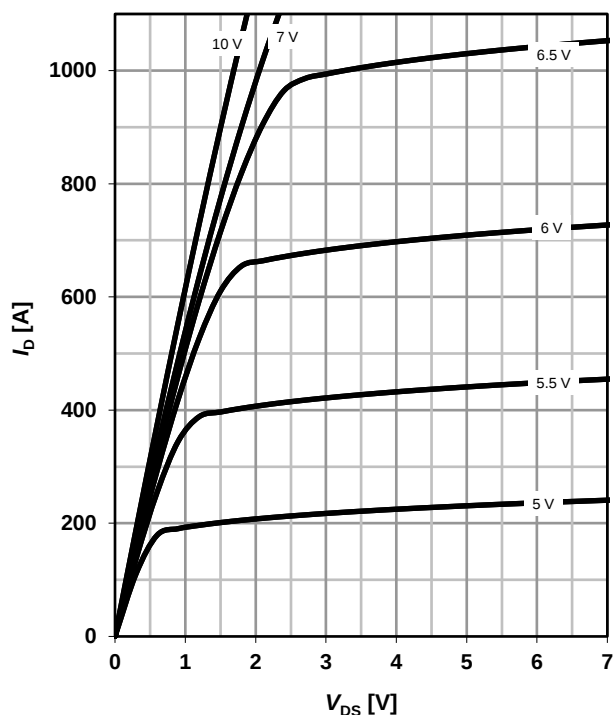
$$Z_{\text{thJC}} = f(t_p)$$

parameter:  $D = t_p/T$



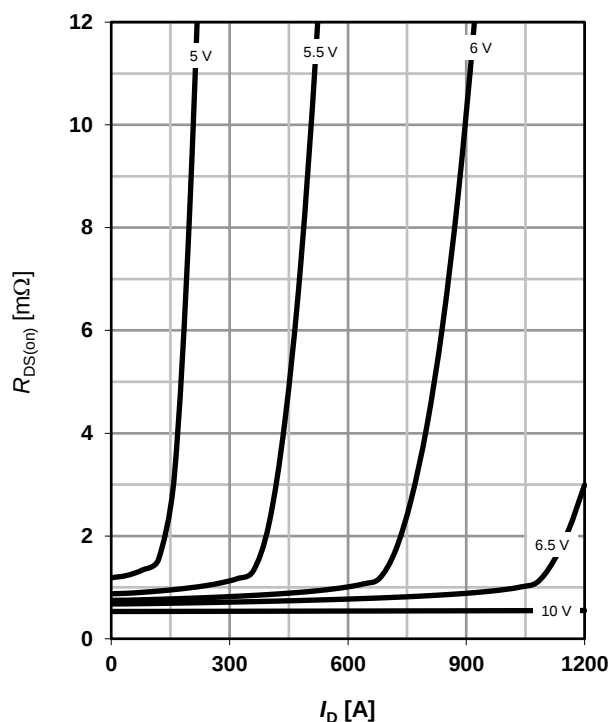
## 5 Typ. output characteristics

 $I_D = f(V_{DS}); T_j = 25^\circ\text{C}$ 

parameter:  $V_{GS}$ 


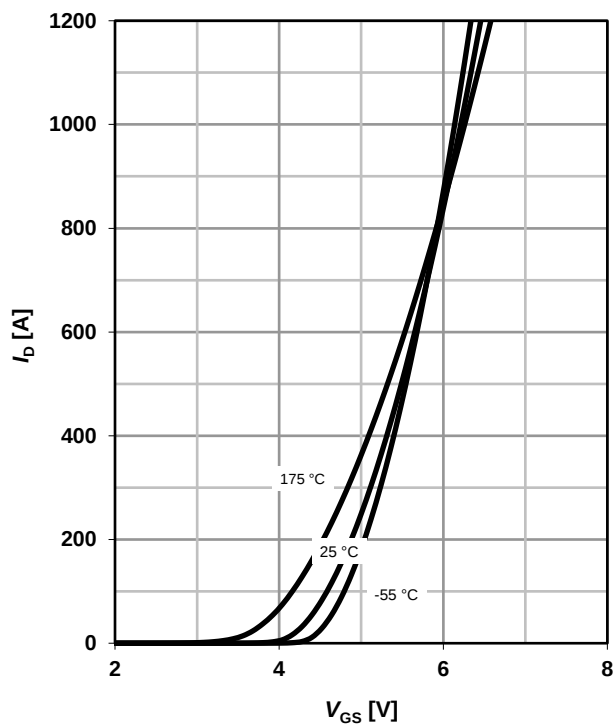
## 6 Typ. drain-source on-state resistance

 $R_{DS(on)} = f(I_D); T_j = 25^\circ\text{C}$ 

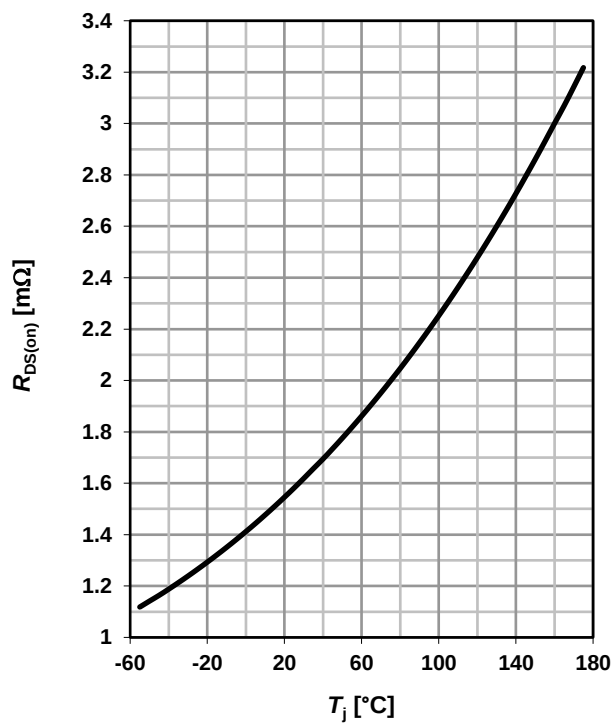
parameter:  $V_{GS}$ 


## 7 Typ. transfer characteristics

 $I_D = f(V_{GS}); V_{DS} = 6\text{ V}$ 

parameter:  $T_j$ 


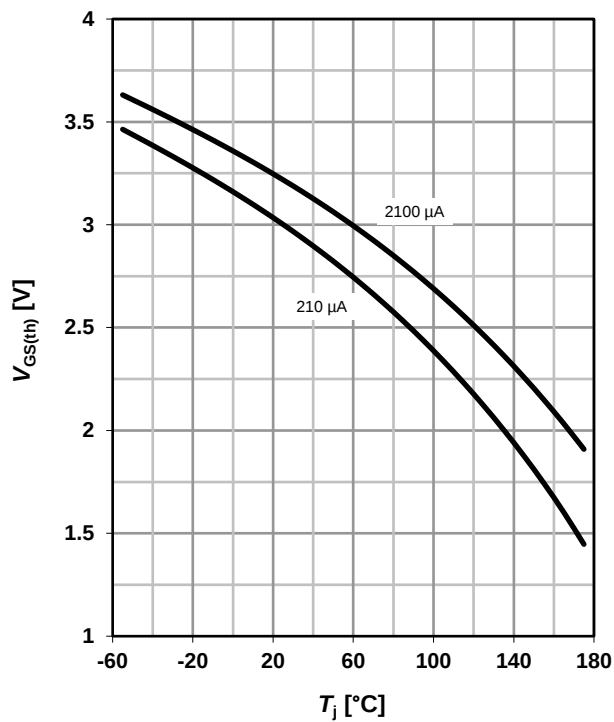
## 8 Typ. drain-source on-state resistance

 $R_{DS(on)} = f(T_j); I_D = 100\text{ A}; V_{GS} = 10\text{ V}$ 


## 9 Typ. gate threshold voltage

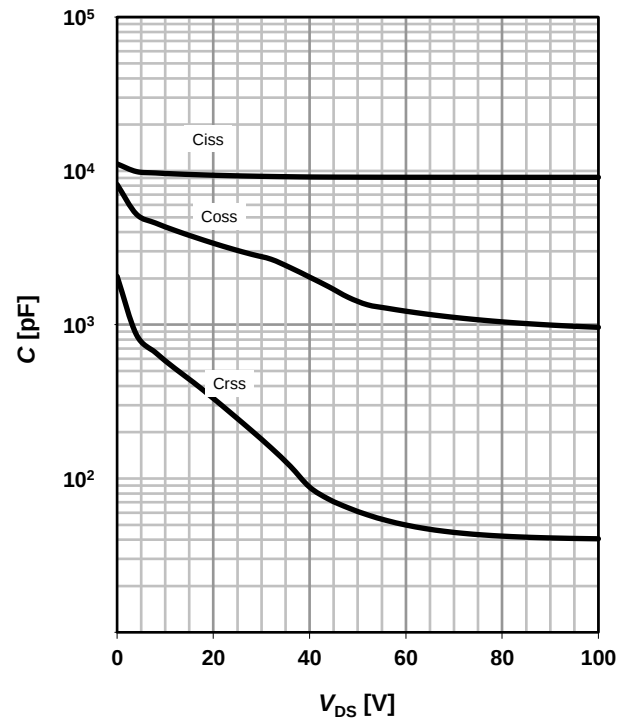
$$V_{GS(th)} = f(T_j); V_{GS} = V_{DS}$$

parameter:  $I_D$



## 10 Typ. capacitances

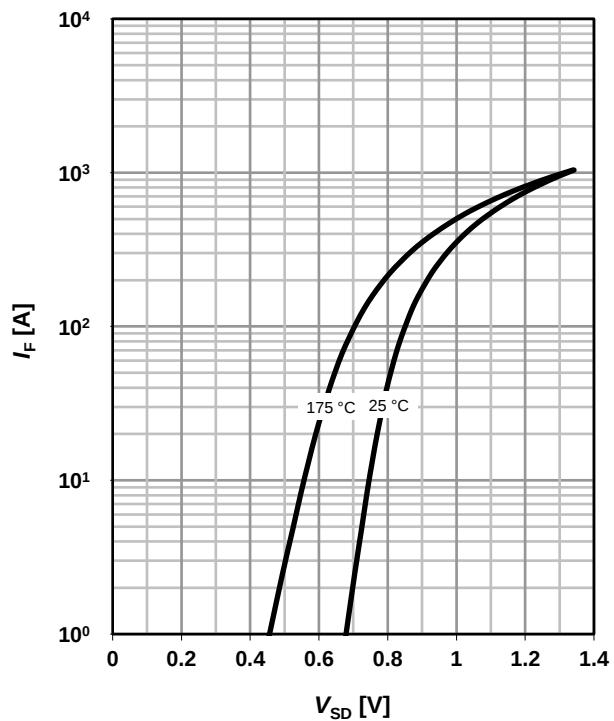
$$C = f(V_{DS}); V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$$



## 11 Typical forward diode characteristics

$$I_F = f(V_{SD})$$

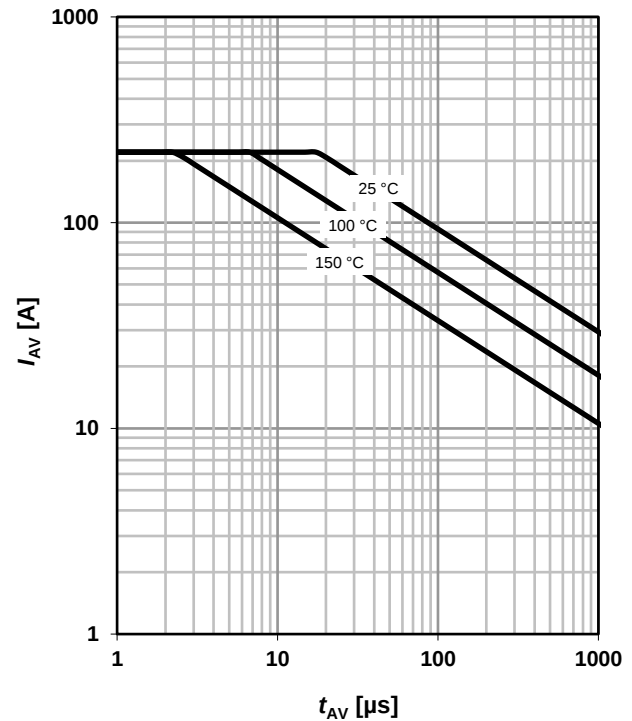
parameter:  $T_j$



## 12 Typ. avalanche characteristics

$$I_{AS} = f(t_{AV})$$

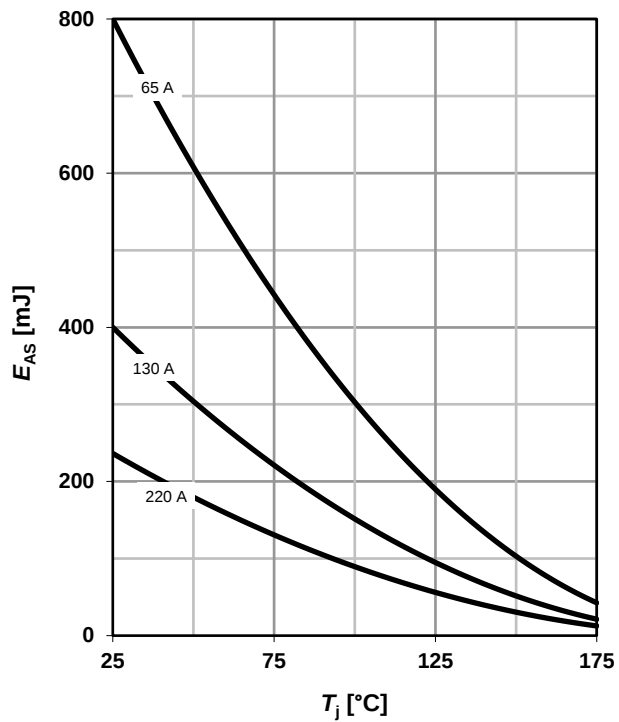
parameter:  $T_{j(start)}$



### 13 Typical avalanche energy

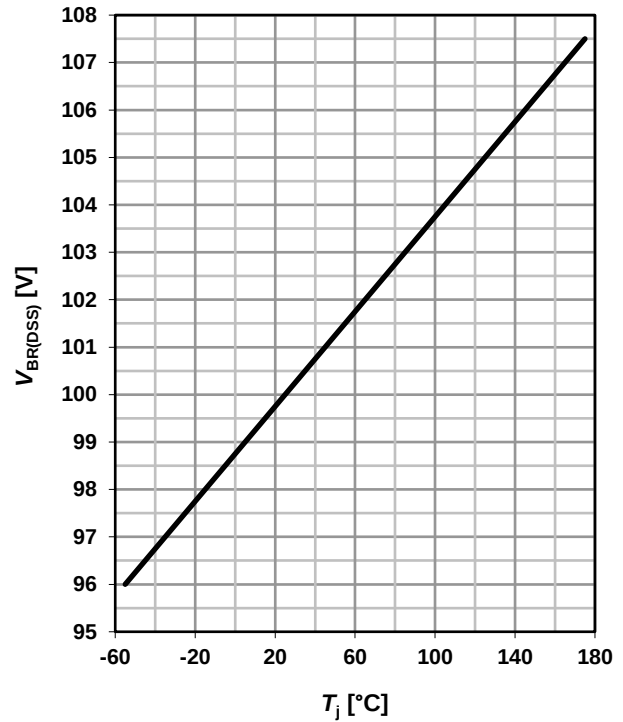
$$E_{AS} = f(T_j)$$

parameter:  $I_D$



### 14 Drain-source breakdown voltage

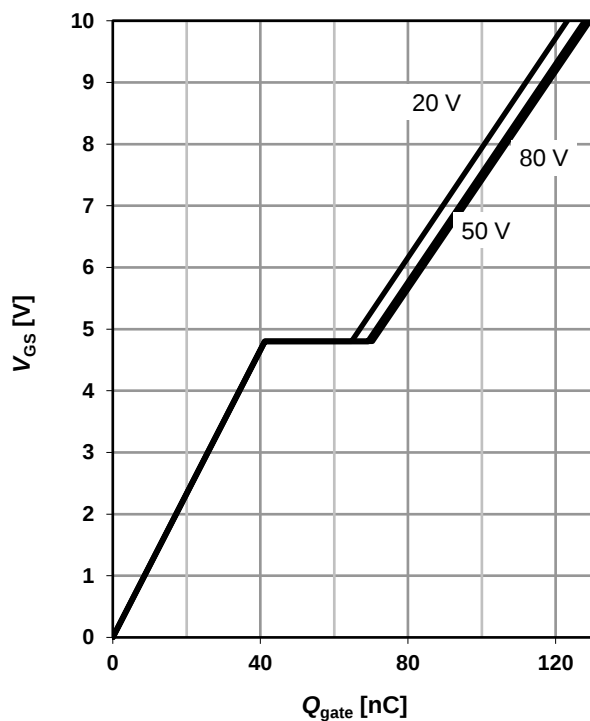
$$V_{BR(DSS)} = f(T_j); I_{D\_typ} = 1\text{ mA}$$



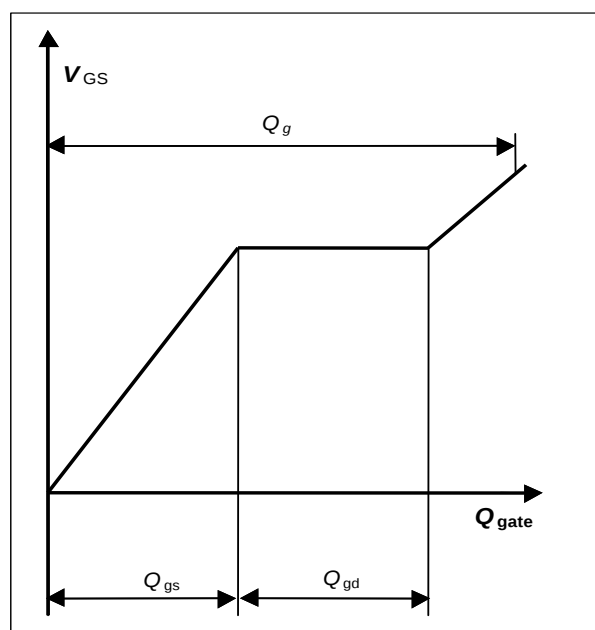
### 15 Typ. gate charge

$$V_{GS} = f(Q_{gate}); I_D = 100\text{ A pulsed}$$

parameter:  $V_{DD}$



### 16 Gate charge waveforms



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## Revision History

| Version     | Date       | Changes                                                            |
|-------------|------------|--------------------------------------------------------------------|
| Version 1.0 | 02.10.2017 | Final Data Sheet                                                   |
| Version 2.0 | 14.03.2019 | Updated avalanche parameters &<br>$R_{DS(on)}$ 6V $I_D$ conditions |

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